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(WO/1997/019584) CUTTING FILAMENT

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Description

Claims

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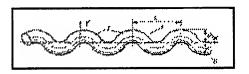
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Title:

CUTTING FILAMENT

Abstract:

The present invention relates to a cutting filament intended for trimming and cutting vegetation, such a cutting filament being used on rotary-head motorized cultivators such as brush cutters and edge trimmers. During use such cutting filaments generate a substantial and unpleasant amount of high-frequent noise which is added to the noise of the motor for driving the rotary head. These noises lead to outdoor



noise pollution. Legislatory requirements aiming to limit the noise to a level deemed to be acceptable are being drawn up and could shortly come into force. The cutting filament according to the present invention is characterized in that the cutting filament (1; 10') has undulations (2; 6; 12') that recur in the

longitudinal direction of the cutting filament (1; 10').

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